

LM5180-Q1 Dual-Output EVM User's Guide

With input voltage range and current capability as specified in [Table 1](#), the family of PSR flyback DC/DC converters from TI provides flexibility, scalability, and optimized solution size for a range of applications. Using an 8-pin WSON package with 4-mm × 4-mm footprint and 0.8-mm pin pitch, these converters enable isolated DC/DC solutions with high density and low component count.

Table 1. PSR Flyback DC/DC Converter Family

PSR FLYBACK CONVERTER	INPUT VOLTAGE RANGE	PEAK SWITCH CURRENT (TYP)	MAXIMUM LOAD CURRENT, $V_{OUT} = 12\text{ V}$, $N_{PS} = 1$		
			$V_{IN} = 4.5\text{ V}$	$V_{IN} = 13.5\text{ V}$	$V_{IN} = 24\text{ V}$
LM5181-Q1	4.5 V to 65 V	0.75 A	90 mA	180 mA	225 mA
LM5180-Q1	4.5 V to 65 V	1.5 A	180 mA	360 mA	450 mA
LM25180-Q1	4.5 V to 42 V	1.5 A	180 mA	360 mA	450 mA
LM25183-Q1	4.5 V to 42 V	2.5 A	300 mA	600 mA	750 mA
LM25184-Q1	4.5 V to 42 V	4.1 A	500 mA	1 A	1.25 A

The [LM5180EVM-DUAL](#) evaluation module (EVM) is a flyback DC/DC converter that employs primary-side regulation (PSR) based on sampling of the primary winding voltage of the transformer to achieve high conversion efficiency in a small footprint. It operates over a wide input voltage range of 10 V to 65 V and delivers dual isolated outputs of 15 V and –7.7 V at 200-mA rated load current. Operating without an optocoupler or transformer auxiliary winding, the converter provides an output voltage with better than ±2% load regulation. The flyback transformer has a turns ratio of 1 : 1: 0.52 (PRI : SEC1 : SEC2) and provides 1500 VRMS primary-to-secondary isolation.

The EVM design uses the [LM5180-Q1](#) PSR flyback converter with wide input voltage (wide V_{IN}) range. An integrated 100-V, 1.5-A power MOSFET provides ample margin for line transients and switch (SW) node voltage spikes related to transformer parasitic leakage inductance. Load regulation errors related to transformer secondary winding resistance are avoided by virtue of the quasi-resonant boundary conduction mode (BCM) control scheme.

Additional features includes current-mode control with internal compensation, hiccup-mode fault protection, low input quiescent current, programmable soft-start, and optional output voltage temperature compensation. UVLO protects the converter at low input voltage conditions, and the EN/UVLO pin supports adjustable input UVLO with user-defined hysteresis for application specific power-up and power-down requirements.

The LM5180 and LM5180-Q1 are available in a 8-pin WSON package with 4-mm × 4-mm footprint and 0.8-mm pin pitch to enable isolated DC/DC solutions with high density and low component count. Wettable flank pins provide a visual indicator of solderability, which reduces the inspection time and manufacturing costs in high-reliability industrial and automotive applications. See the [LM5180](#) and [LM5180-Q1](#) device data sheets for more information.

Use the LM5180-Q1 with [WEBENCH® Power Designer](#) to create a custom regulator design. Furthermore, the user can download the [LM5180 Quickstart Calculator](#) to optimize component selection and examine predicted efficiency performance across line and load ranges.

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14	Start-Up, $V_{IN} = 24$ V, $I_{OUT1} = -I_{OUT2} = 200$ mA Resistive	13
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1 High Density EVM Description

The [LM5180EVM-DUAL](#) EVM is designed to use a regulated or non-regulated high-voltage input rail ranging from 10 V to 65 V to produce a tightly-regulated, isolated output voltages of 15 V and –7.7 V at load currents up to 200 mA. This wide V_{IN} range isolated DC/DC solution offers outsized voltage rating and operating margin to withstand supply rail voltage transients.

The power-train passive components selected for this EVM, including flyback transformer, flyback rectifying diodes, and ceramic input and output capacitors, are available from multiple component vendors. Transformers with functional or basic grade isolation are available with isolation voltages of 1.5 kV and greater.

1.1 Typical Applications

- [Automotive HEV/EV powertrain systems](#)
- Sub-AM band [automotive body electronics](#)
- [Traction inverters](#): IGBT and SiC gate drivers
- [Isolated field transmitters](#) and [field actuators](#)
- [Building automation HVAC systems](#)
- Isolated bias power rails

1.2 Features and Electrical Performance

- Tightly-regulated, isolated output voltages of 15 V and –7.7 V with better than $\pm 2\%$ load regulation from 1% to 100% load
- Wide input voltage operating range of 10 V to 65 V
- Full load current of 200 mA, both outputs
- Maximum switching frequency of 350 kHz remains below the AM band for automotive applications
- High efficiency across wide load current range
 - Full load efficiency of 88% and 87.5% at $V_{IN} = 24$ V and 48 V, respectively
 - 88.5% efficiency at half-rated load, $V_{IN} = 24$ V
- 1.4-mA and 1.1-mA no-load supply current at $V_{IN} = 24$ V and 48 V, respectively
- Ultra-low conducted and radiated EMI signatures
 - Optimized for CISPR 25 class 5 requirements
 - Soft switching avoids diode reverse recovery
 - Input π -stage EMI filter with damping from electrolytic capacitor ESR
- Boundary conduction mode (BCM) control architecture provides fast line and load transient response
 - Peak current-mode control
 - Quasi-resonant switching for reduced power loss
 - Internal loop compensation
- Integrated 100-V flyback power MOSFET
 - Provides large headroom for input voltage transients
- Cycle-by-cycle overcurrent protection (OCP)
- Monotonic prebias output voltage start-up
- User-adjustable soft-start time set to 8 ms by 47-nF capacitor connected between SS/BIAS and GND
 - Option for external bias using transformer auxiliary winding connected to SS/BIAS
- Resistor-programmable input voltage UVLO with customizable hysteresis for applications with wide turn-on and turn-off voltage difference
 - Input UVLO set to turn on and off at V_{IN} of 9 V and 7 V, respectively
- Low transformer primary-to-secondary (interwinding) capacitance to accommodate high dv/dt secondary-side common-mode swings
- Fully assembled, tested, and proven PCB layout with 55-mm × 38-mm total footprint

2 EVM Performance Characteristics

Table 2. Electrical Performance Characteristics

PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT	
INPUT CHARACTERISTICS							
Input voltage range, V_{IN}	Operating		10	48	65	V	
Input voltage turnon, $V_{IN(ON)}$	Adjusted using EN/UVLO divider resistors		9				
Input voltage turnoff, $V_{IN(OFF)}$			7				
Input voltage hysteresis, $V_{IN(HYS)}$			2				
Input current, no load, $I_{IN(NL)}$	$I_{OUT1} = I_{OUT2} = 0\text{ mA}$	$V_{IN} = 24\text{ V}$	1.4			mA	
		$V_{IN} = 48\text{ V}$	1.1				
		$V_{IN} = 65\text{ V}$	1				
Input current, disabled, $I_{IN(OFF)}$	$V_{EN} = 0\text{ V}$	$V_{IN} = 24\text{ V}$	10			μA	
OUTPUT CHARACTERISTICS							
Output voltage, V_{OUT1} ⁽¹⁾	$I_{OUT1/2} = 5\text{ mA to }200\text{ mA}$		14.7	15.0	15.3	V	
Output voltage, V_{OUT2} ⁽¹⁾			−7.5	−7.7	−7.9	V	
Output current, I_{OUT1} , $-I_{OUT2}$ ⁽²⁾	$V_{IN} = 12\text{ V}$		0			180	mA
	$V_{IN} = 24\text{ V}$		0			220	
	$V_{IN} = 48\text{ V}$		0			300	
	$V_{IN} = 70\text{ V}$		0			350	
Output voltage regulation, ΔV_{OUT}	Load regulation, $V_{IN} = 24\text{ V}$	$I_{OUT} = 5\text{ mA to }200\text{ mA}$	1%				
	Line regulation, $I_{OUT} = 100\text{ mA}$	$V_{IN} = 10\text{ V to }65\text{ V}$	1%				
Output voltage ripple, $V_{OUT(AC)}$	$V_{IN} = 24\text{ V}$, $I_{OUT1} = I_{OUT2} = 200\text{ mA}$		100			mVrms	
Output overcurrent protection, I_{OCP}	$V_{IN} = 24\text{ V}$		250			mA	
Soft-start time, t_{SS}	$C_{SS} = 47\text{ nF}$		8			ms	
SYSTEM CHARACTERISTICS							
Switching frequency, $F_{SW(nom)}$	$V_{IN} = 24\text{ V}$, $I_{OUT1} = I_{OUT2} = 100\text{ mA}$		350			kHz	
Half-load efficiency, η_{HALF} ⁽¹⁾	$I_{OUT1} = I_{OUT2} = 100\text{ mA}$	$V_{IN} = 12\text{ V}$	88.5%				
		$V_{IN} = 24\text{ V}$	88.5%				
		$V_{IN} = 48\text{ V}$	86%				
		$V_{IN} = 65\text{ V}$	85%				
Full load efficiency, η_{FULL}	$I_{OUT1} = I_{OUT2} = 200\text{ mA}$	$V_{IN} = 24\text{ V}$	88%				
		$V_{IN} = 48\text{ V}$	87.5%				
		$V_{IN} = 65\text{ V}$	87%				
Isolation rating ⁽³⁾	Functional insulation		1500			V	
LM5180 junction temperature, T_J			−40			150	°C

⁽¹⁾ The default output voltages of this EVM are 15 V and −7.7 V. Efficiency and other performance metrics can change based on operating input voltage, load currents, externally-connected output capacitance(s), and other parameters.

⁽²⁾ The output power delivered by the LM5180-Q1 PSR flyback converter increases with input voltage.

⁽³⁾ The selected transformer provides functional isolation.

3 Application Circuit Diagram

Figure 1 shows the schematic of an LM5180-based flyback converter (EMI filter stage not shown). Soft start (SS), temperature compensation (TC), and UVLO (EN/UVLO) components are shown that are configurable as required by the specific application. The transformer turns ratio is 1 : 1 : 0.52 and the primary-referred magnetizing inductance is 30 μ H.

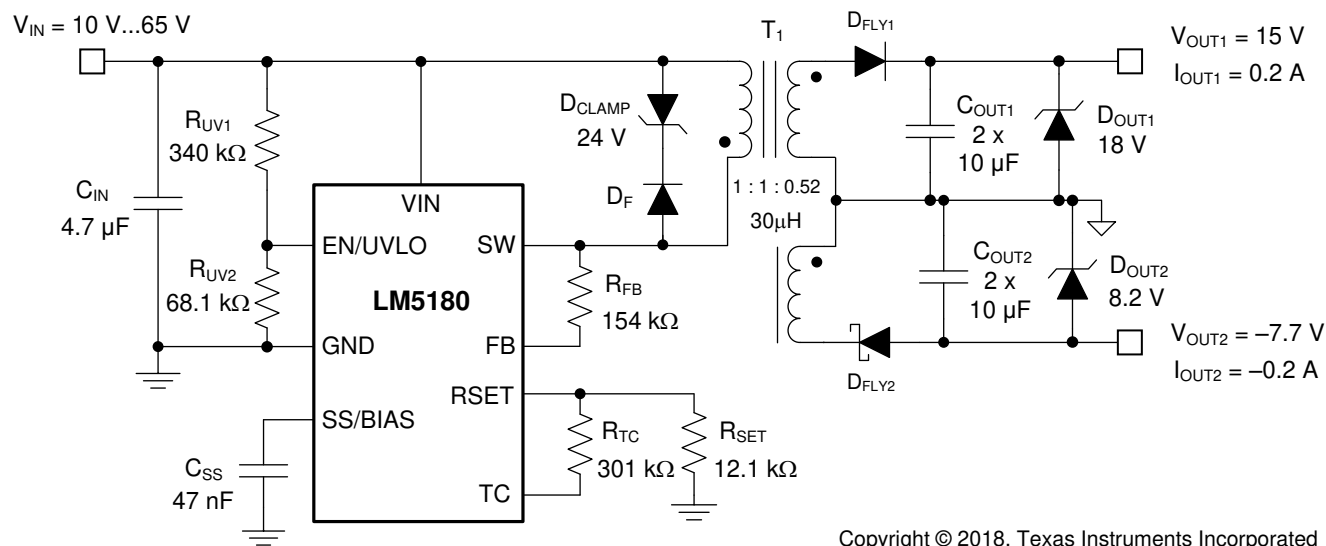


Figure 1. LM5180 PSR Flyback Dual-Output Schematic

4 EVM Photo

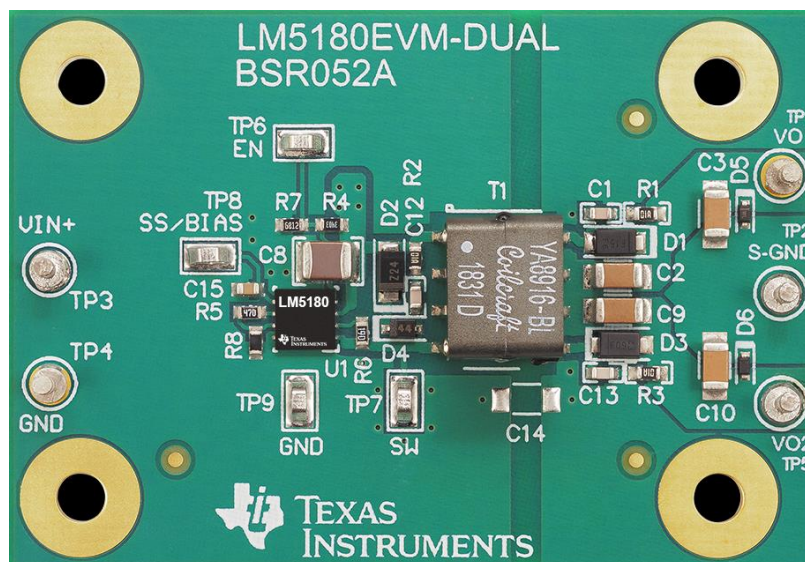


Figure 2. Dual-Output EVM Photo, 55 mm × 38 mm

5 Test Setup and Procedure

5.1 Test Setup

Table 3. EVM Connections

LABEL	DESCRIPTION
VIN+	Positive input voltage power and sense connection
VIN-	Negative input voltage power and sense connection
VOUT1	Output #1 power and sense connection
VOUT2	Output #2 power and sense connection
S-GND	Output return and sense connection
EN	ENABLE input – tie to GND to disable converter
SS/BIAS	External BIAS input
SW	SW node connection

Referencing the EVM connections described in Table 3, the recommended test setup to evaluate the LM5180EVM-DUAL is shown in Figure 3. Working at an ESD-protected workstation, make sure that any wrist straps, boot straps, or mats are connected and referencing the user to earth ground before power is applied to the EVM.

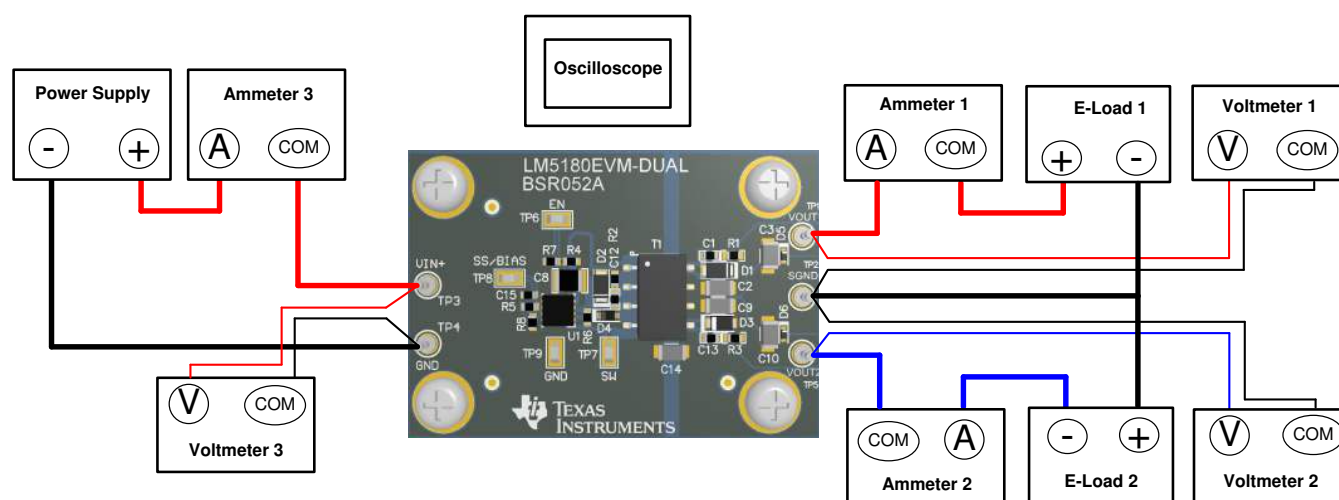


Figure 3. EVM Test Setup

CAUTION

Refer to the [LM5180](#) and [LM5180-Q1](#) data sheets, [LM5180 Quickstart Calculator](#), and [WEBENCH® Power Designer](#) for additional guidance pertaining to component selection and converter operation.

5.2 Test Equipment

Voltage Source: The input voltage source V_{IN} must be a 0–65-V variable DC source.

Multimeters:

- **Voltmeter 1:** Input voltage at VIN+ to VIN–. Set voltmeter to an input impedance of 100 M Ω .
- **Voltmeter 2:** Output voltage at VOUT1 to SGND. Set voltmeter to an input impedance of 100 M Ω .
- **Voltmeter 3:** Output voltage at VOUT2 to SGND. Set voltmeter to an input impedance of 100 M Ω .
- **Ammeter 1:** Input current. Set ammeter to 1-second aperture time.
- **Ammeter 2:** Load current, output #1. Set ammeter to 1-second aperture time.
- **Ammeter 3:** Load current, output #2. Set ammeter to 1-second aperture time.

Electronic Loads: The loads must be electronic constant-resistance (CR) or constant-current (CC) mode load capable of 0 A to 300 mA up to 15 V. For a no-load input current measurement, disconnect the electronic load as it may draw a small residual current.

Oscilloscope: With the scope set to 20-MHz bandwidth and AC coupling, measure the output voltage ripple directly across an output capacitor with a short ground lead normally provided with the scope probe. Place the oscilloscope probe tip on the positive terminal of the output capacitor, holding the ground barrel of the probe through the ground lead to the negative terminal of the capacitor. TI does not recommend using a long-leaded ground connection because this may induce additional noise given a large ground loop. To measure other waveforms, adjust the oscilloscope as needed.

Safety: Always use caution when touching any circuits that may be live or energized.

5.3 Recommended Test Setup

5.3.1 Input Connections

- Prior to connecting the DC input source, set the current limit of the input supply to 100 mA maximum. Ensure the input source is initially set to 0 V and connected to the VIN+ and VIN– connection points as shown in [Figure 3](#). An additional input bulk capacitor is recommended to provide damping if long input lines are used.
- Connect voltmeter 3 at VIN+ and VIN– connection points to measure the input voltage.
- Connect ammeter 3 to measure the input current and set to at least 1-second aperture time.

5.3.2 Output Connections

- Connect electronic loads to VOUT1, VOUT2, and SGND connections as shown in [Figure 3](#). Set the load to constant-resistance mode or constant-current mode at 0 A before applying input voltage.
- Connect voltmeters 1 and 2 at VOUT1, VOUT2, and SGND connection points to measure the output voltages.
- Connect ammeters 1 and 2 to measure the output currents.

5.4 Test Procedure

5.4.1 Line and Load Regulation, Efficiency

- Set up the EVM as described above.
- Set load to constant resistance or constant current mode and to sink 10 mA.
- Increase input source from 0 V to 24 V; use voltmeter 3 to measure the input voltage.
- Increase the current limit of the input supply to 500 mA.
- Using voltmeters to measure the respective output voltages, vary both loads from 10 mA to 200 mA DC; V_{OUT1} and V_{OUT2} must remain within the load regulation specification.
- Set the load currents to 100 mA (50% rated load) and vary the input source voltage from 10 V to 65 V; V_{OUT1} and V_{OUT2} must remain within the line regulation specification.
- Decrease loads to 10 mA. Decrease input source voltage to 0 V.

6 Test Data and Performance Curves

Figure 4 through Figure 16 present typical performance curves for the LM5180EVM-DUAL. Because actual performance data can be affected by measurement techniques and environmental variables, these curves are presented for reference and can differ from actual field measurements.

6.1 Efficiency and Regulation

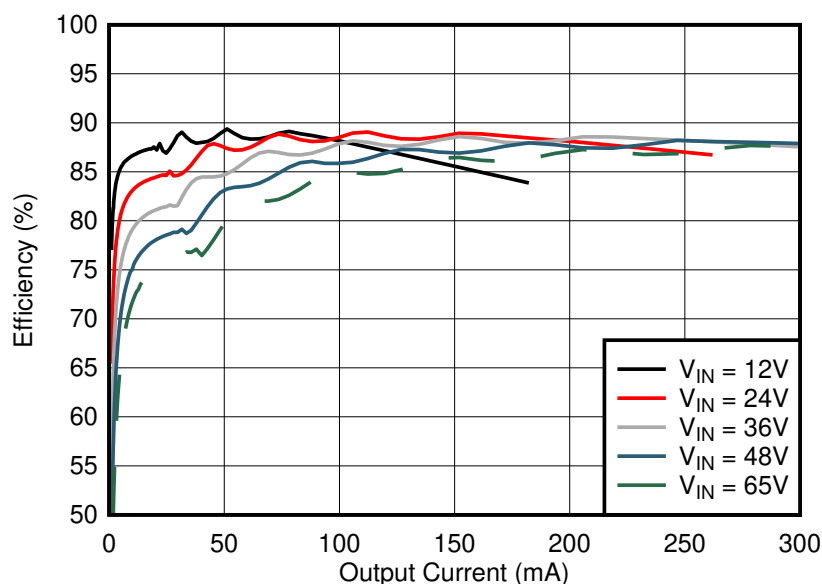


Figure 4. Conversion Efficiency (Linear Scale), Outputs Loaded Symmetrically

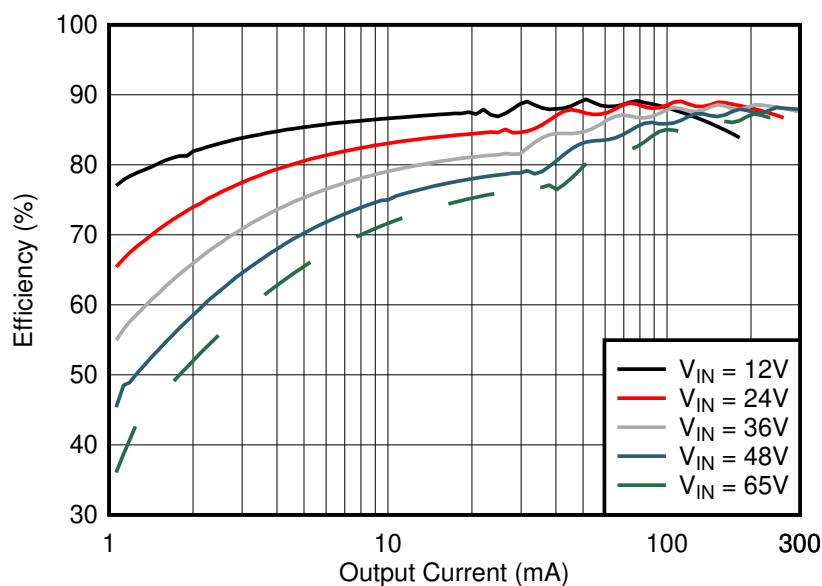


Figure 5. Conversion Efficiency (Log Scale), Outputs Loaded Symmetrically

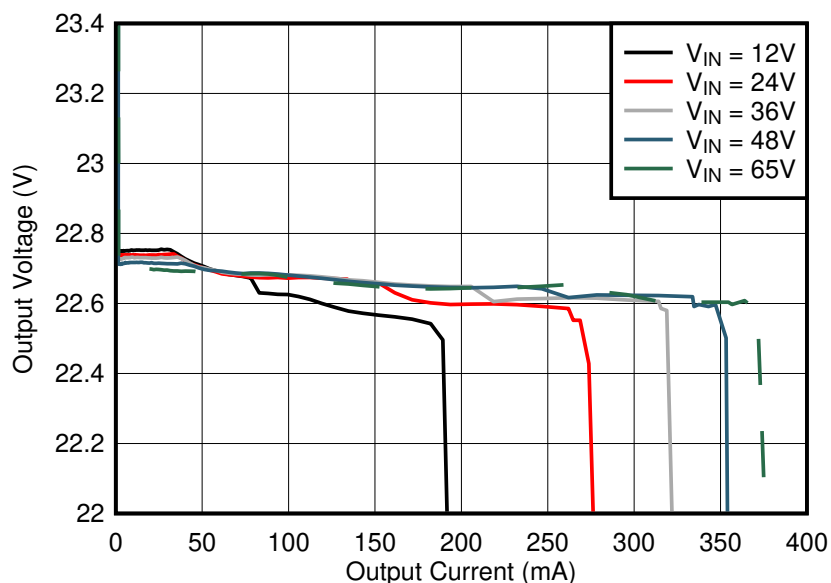


Figure 6. Load Regulation (Linear Scale), Sum of V_{OUT1} and V_{OUT2} Measured, Outputs Loaded Symmetrically

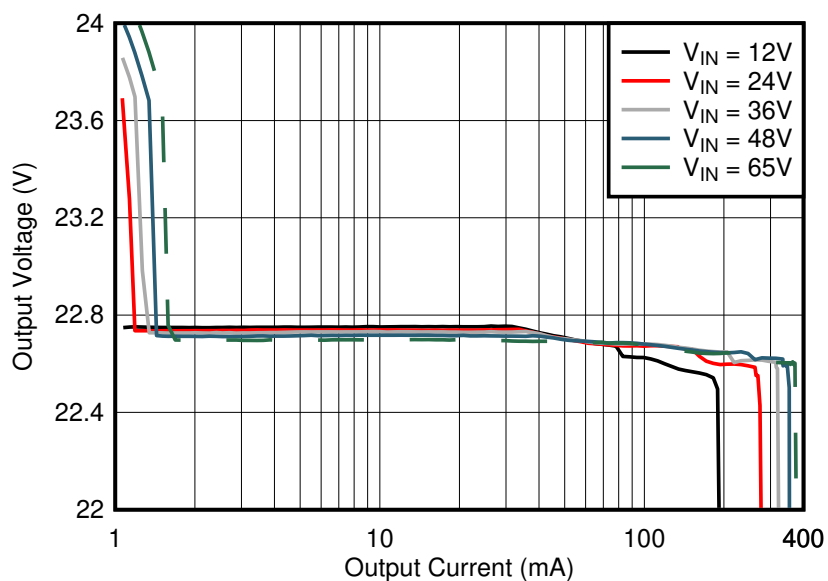


Figure 7. Load Regulation (Log Scale), Sum of V_{OUT1} and V_{OUT2} Measured, Outputs Loaded Symmetrically

6.2 Operating Waveforms

6.2.1 Switching

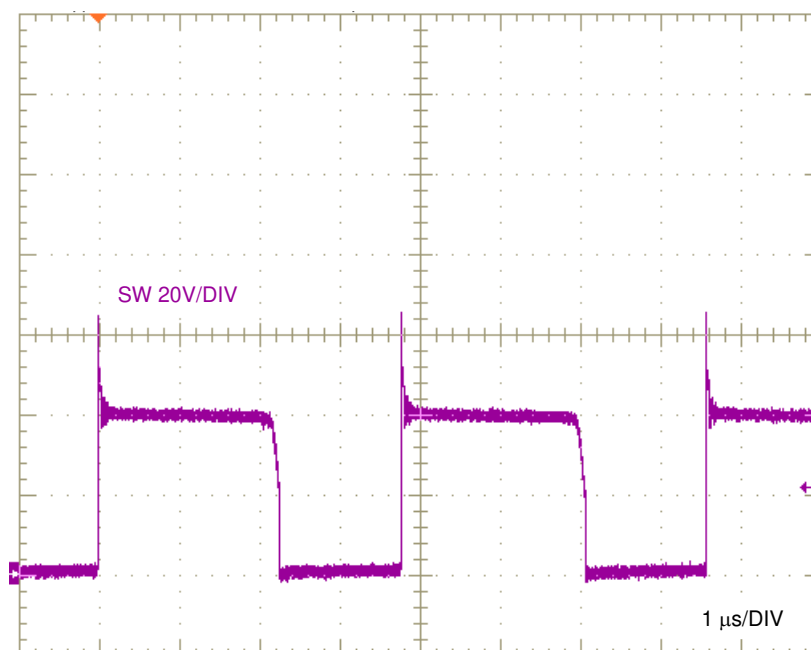


Figure 8. SW Node Voltage, $I_{OUT1} = -I_{OUT2} = 200\text{ mA}$, $V_{IN} = 24\text{ V}$

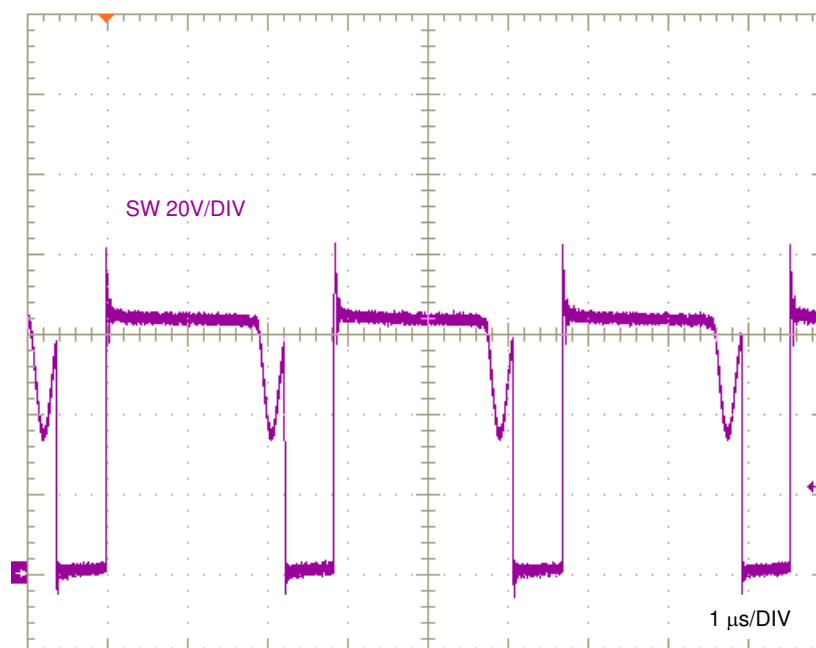


Figure 9. SW Node Voltage, $I_{OUT1} = -I_{OUT2} = 200\text{ mA}$, $V_{IN} = 48\text{ V}$

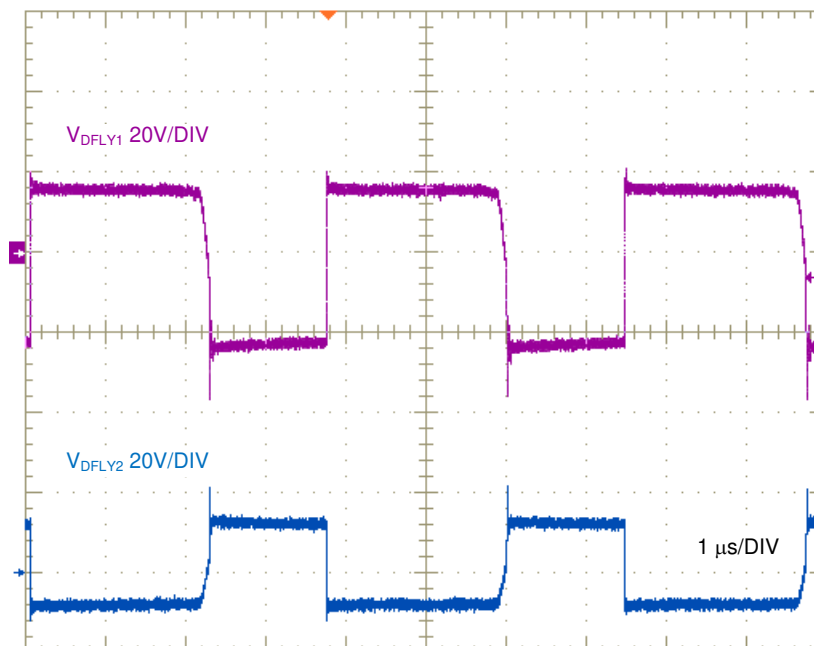


Figure 10. Flyback Diode Voltages, $I_{OUT1} = -I_{OUT2} = 200\ \text{mA}$, $V_{IN} = 24\ \text{V}$

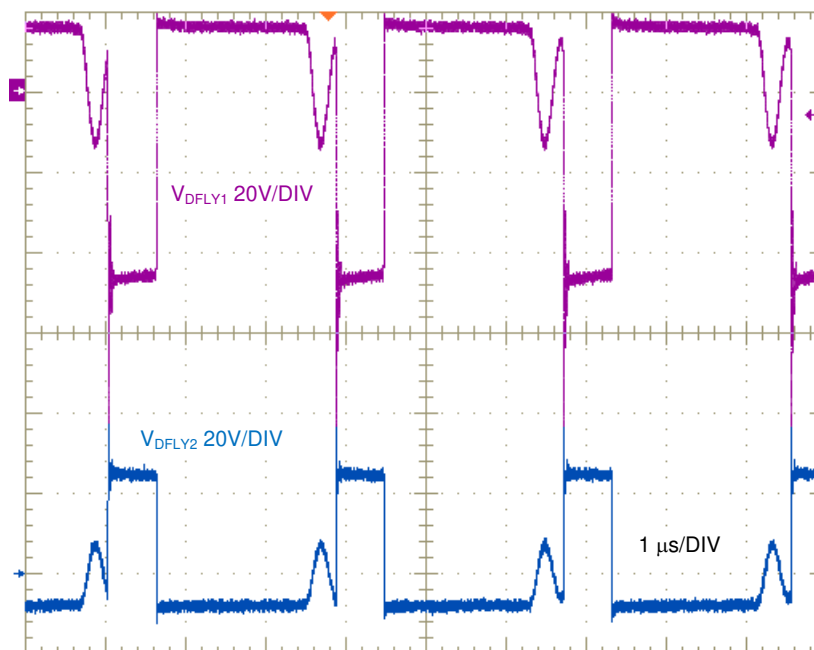


Figure 11. Flyback Diode Voltages, $I_{OUT1} = -I_{OUT2} = 200\ \text{mA}$, $V_{IN} = 48\ \text{V}$

6.2.2 Load Transient Response

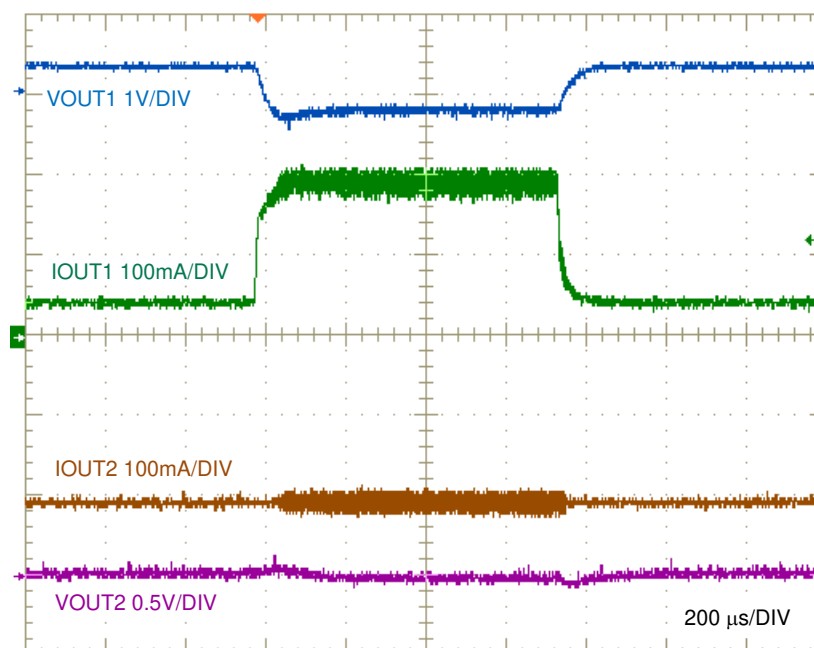


Figure 12. Output 1 Load Transient, 50 mA to 200 mA at 100mA/ μs , $I_{\text{OUT}2} = -200 \text{ mA}$, $V_{\text{IN}} = 24 \text{ V}$

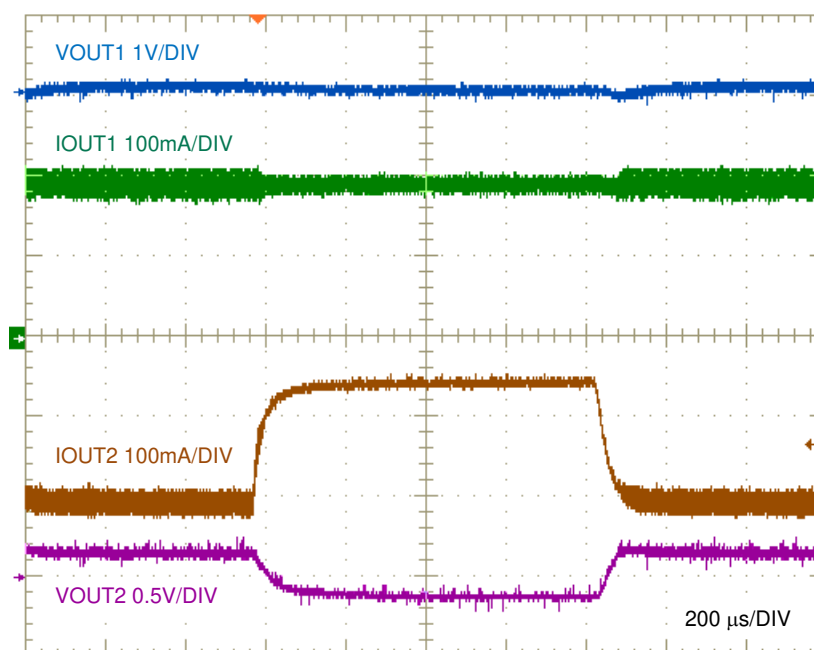


Figure 13. Output 2 Load Transient, 50 mA to 200 mA at 100mA/ μs , $I_{\text{OUT}1} = 200 \text{ mA}$, $V_{\text{IN}} = 24 \text{ V}$

6.2.3 Start-Up, Enable, and Short Circuit Recovery ⁽¹⁾

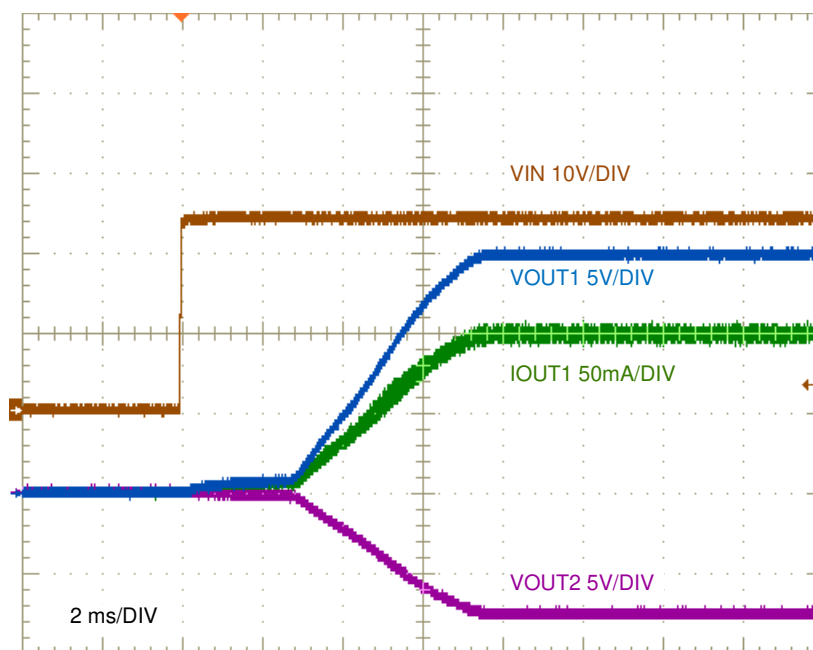


Figure 14. Start-Up, $V_{IN} = 24\text{ V}$, $I_{OUT1} = -I_{OUT2} = 200\text{ mA}$ Resistive

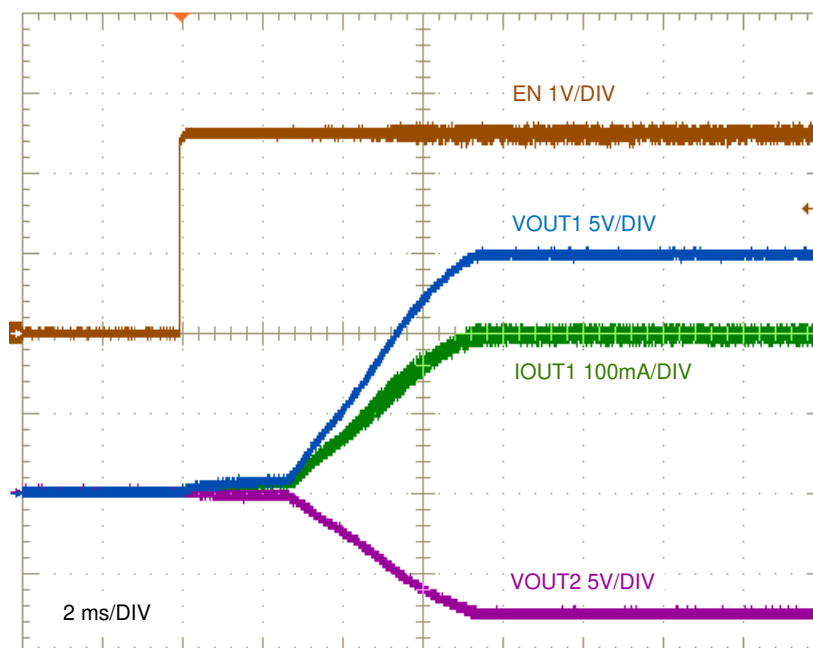


Figure 15. Enable On, $V_{IN} = 24\text{ V}$, $I_{OUT1} = -I_{OUT2} = 200\text{ mA}$ Resistive

⁽¹⁾ The internal soft-start timer is applicable here as the SS cap was not installed during these startup tests.

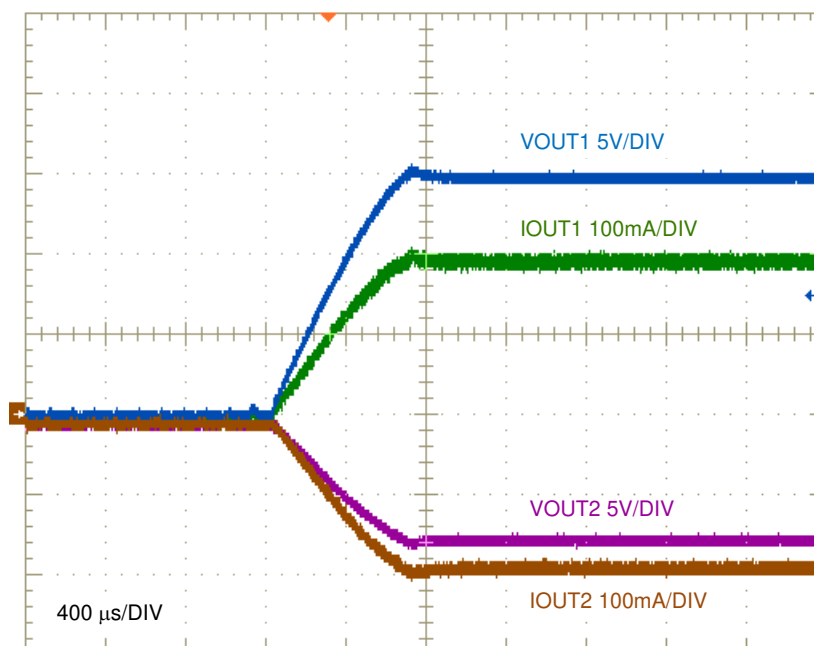
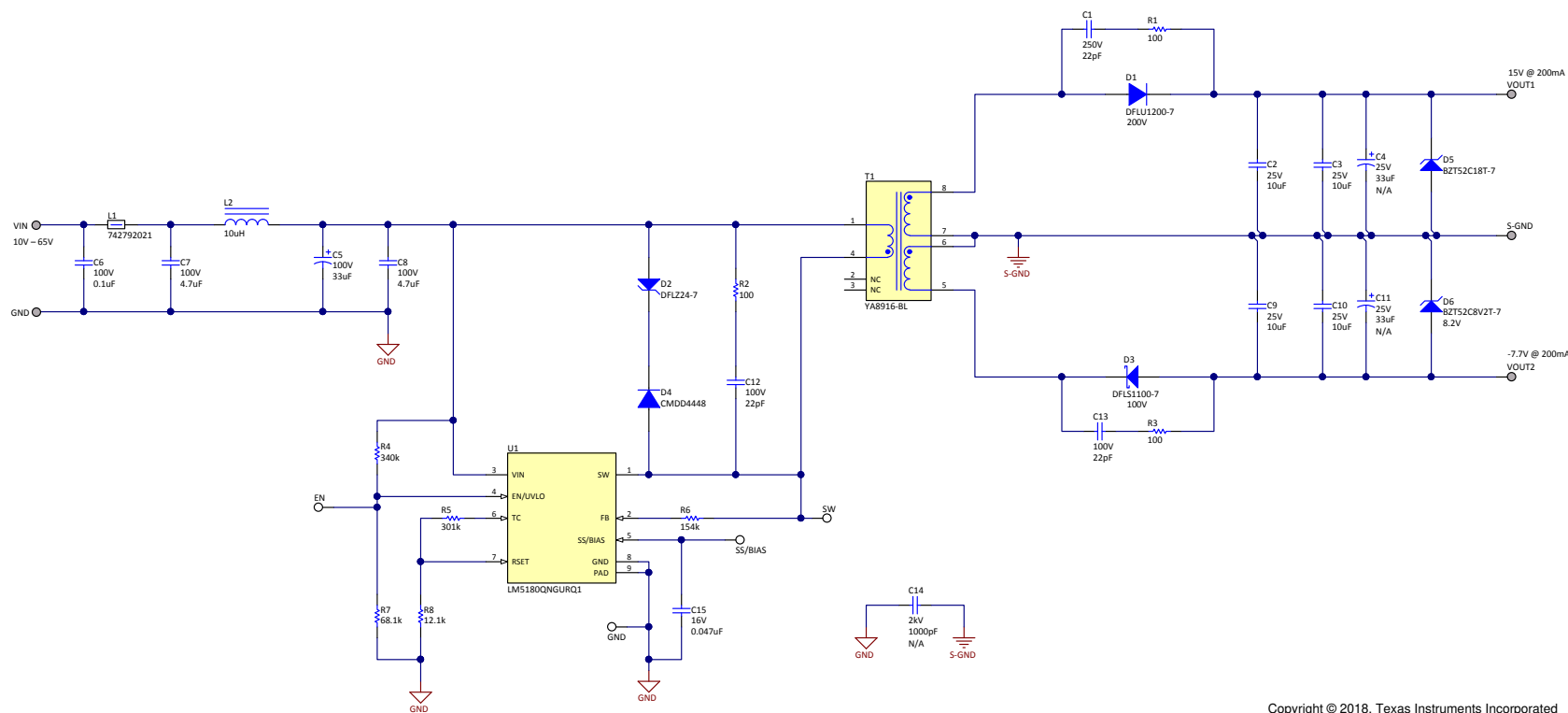


Figure 16. Short Circuit Recovery, $V_{IN} = 24\text{ V}$, $I_{OUT1} = -I_{OUT2} = 200\text{ mA}$ Resistive

7 EVM Documentation

7.1 Schematic



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Figure 17. EVM Schematic

7.2 Bill of Materials

Table 4. Bill of Materials

COUNT	REF DES	DESCRIPTION	PART NUMBER	MFR
1	C1	Capacitor, Ceramic, 22 pF, 250 V, X7R, 0603	Std	Std
2	C2, C3	Capacitor, Ceramic, 10 μ F, 25 V, X7R, 1206	GRM32ER60J107ME20	Murata
			885012109004	Würth Elektronik
			12106D107KAT2A	AVX
1	C5	Aluminum Electrolytic, 10 μ F, 100 V, $\pm$ 20%	865060845002	Würth Elektronik
		Aluminum Electrolytic, 33 μ F, 100 V, $\pm$ 20%, AEC-Q200 grade 2	EEE-FK2A330P	Panasonic
1	C6	Capacitor, Ceramic, 0.1 μ F, 100 V, X7R, 0603	C1608X7R1A105K080AC	TDK
2	C7, C8	Capacitor, Ceramic, 4.7 μ F, 100 V, X7S, 1210	C3225X7S2A475M200AB	TDK
			GRJ32DC72A475KE11L	Murata
2	C9, C10	Capacitor, Ceramic, 22 μ F, 16 V, X6S, 1206	C3216X6S1C226M160AC	TDK
		Capacitor, Ceramic, 22 μ F, 16 V, X7S, 1206	GRM31CC71C226ME11L	Murata
2	C12, C13	Capacitor, Ceramic, 22 pF, 100 V, X7R, 0603	Std	Std
1	C14	Capacitor, Ceramic, 1 nF, 2 kV, X7R, 1206	Std	Std
1	C15	Capacitor, Ceramic, 47 nF, 16 V, X7R, 0603	Std	Std
1	D1	Switching Diode, 200 V, 1 A, SOD-123	DFLU1200-7	Diodes Inc.
1	D2	Zener, 24 V, 1 W, PowerDI-123, AEC-Q101	DFLZ24-7	Diodes Inc.
		Zener, 24 V, 1 W, SOD-123	DFLZ24-TP	Micro Commercial
1	D3	Schottky Diode, 100 V, 1 A, SOD-123	DFLS1100-7	Diodes Inc.
1	D4	Switching Diode, 100 V, 1 A, SOD-323	CMDD4448	Central Semi
1	D5	Zener, 18 V, SOD-523	BZT52C18VT-7	Diodes Inc.
1	D6	Zener, 8.2 V, SOD-523	BZT52C8V2T-7	Diodes Inc.
1	L1	Ferrite bead, 22 Ω at 100 MHz, 8 m Ω max, 6 A	742792021	Würth Elektronik
1	L2	Inductor, 10 μ H $\pm$ 20%, 150 m Ω max, 1.3 A	744042100	Würth Elektronik
1	T1	Flyback transformer, 30 μ H, 2 A, 1 : 1 : 0.52 turns ratio, 9 $\times$ 10 mm	YA8916-BL	Coilcraft
			750317595	Würth Elektronik
3	R1, R2, R3	Resistor, Chip, 100 Ω , 1/8W, 5%, 0805	Std	Std
1	R4	Resistor, Chip, 340 k Ω , 1/16W, 1%, 0603	Std	Std
1	R5	Resistor, Chip, 200 k Ω , 1/16W, 1%, 0603	Std	Std
1	R6	Resistor, Chip, 154 k Ω , 1/16W, 1%, 0603	Std	Std
1	R7	Resistor, Chip, 68.1 k Ω , 1/16W, 1%, 0603	Std	Std
1	R8	Resistor, Chip, 12.1 k Ω , 1/16W, 1%, 0603	Std	Std
1	U1	IC, LM5180-Q1 , wide V_{IN} PSR flyback converter, WSON-8	LM5180QNGURQ1	TI
1	PCB1	PCB, FR4, 2 layer, 1 oz, 55 mm $\times$ 38 mm	PCB	—
5	J1, J2, J3, J4, J5	Turret, PTH, 4.72 mm, VIN+, VIN–, VOUT+, VOUT–, SGND	1573-2	Keystone Electronics
4	TP1, TP2, TP3, TP4	Test point for EN, SW, SS/BIAS, GND	5015	Keystone Electronics

7.3 PCB Layout

Figure 18 through Figure 21 show the design of the LM5180 2-layer PCB with 1-oz copper thickness. The EVM is a two-sided design with post connections for VIN+, VIN-, VOUT1+, VOUT2+, and SGND.

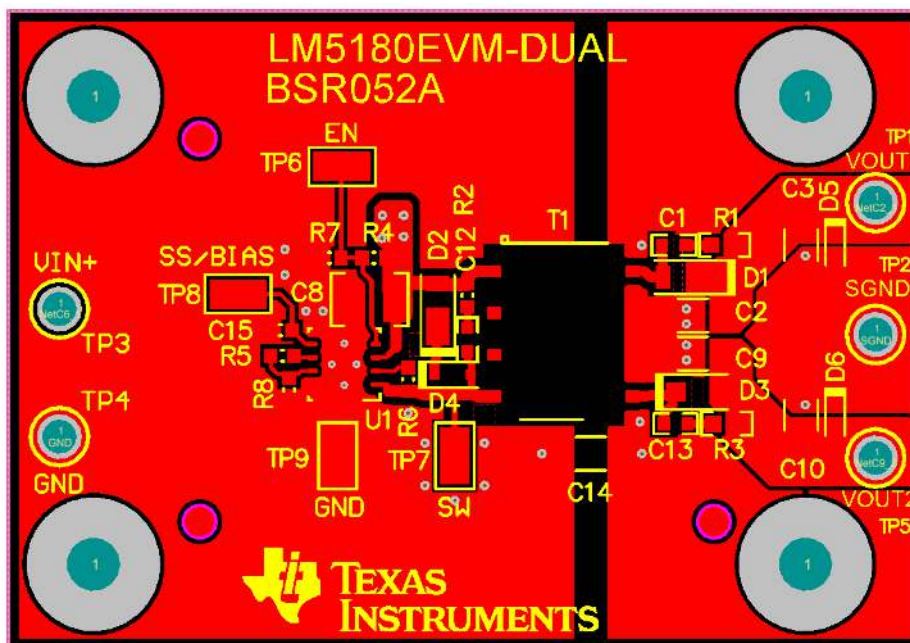


Figure 18. Top Copper (Top View)

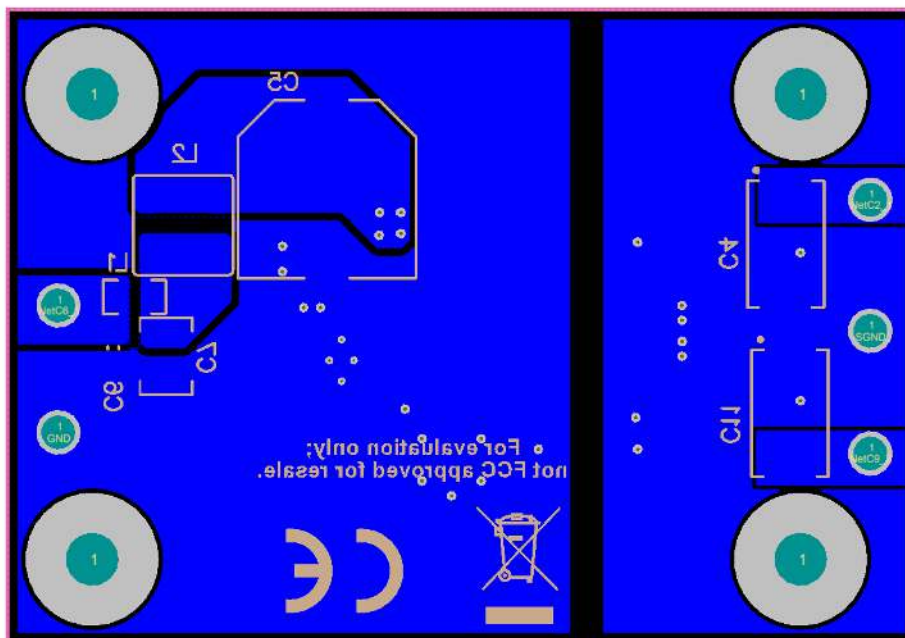


Figure 19. Bottom Copper (Top View)

7.4 Assembly Drawings

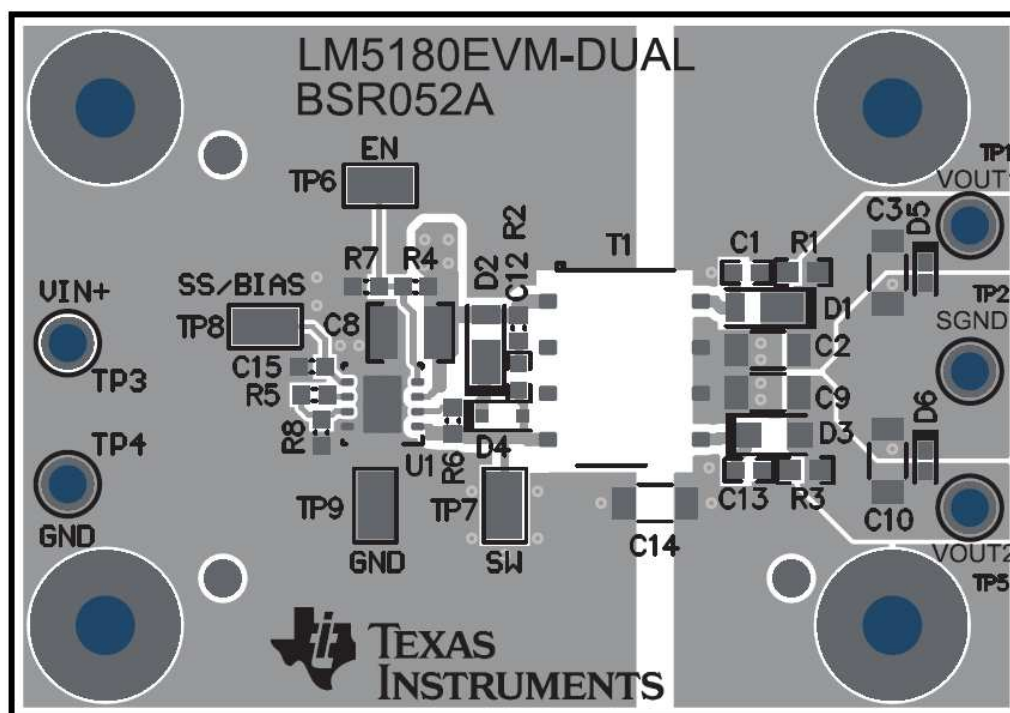


Figure 20. Top Assembly

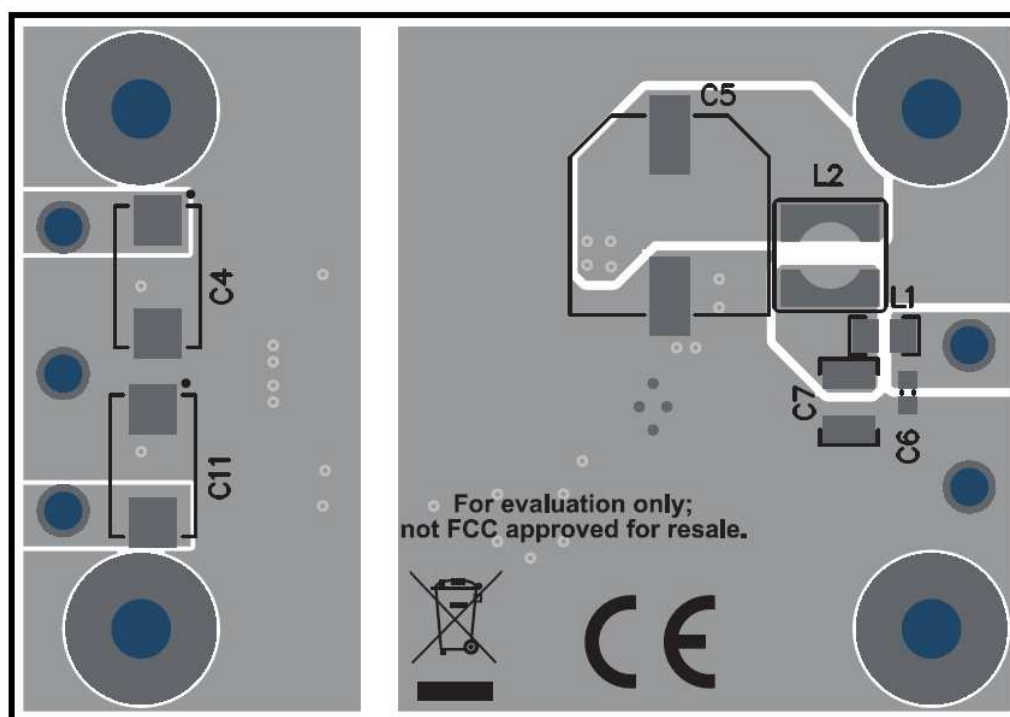


Figure 21. Bottom Assembly

7.4.1 PCB Layout Tips

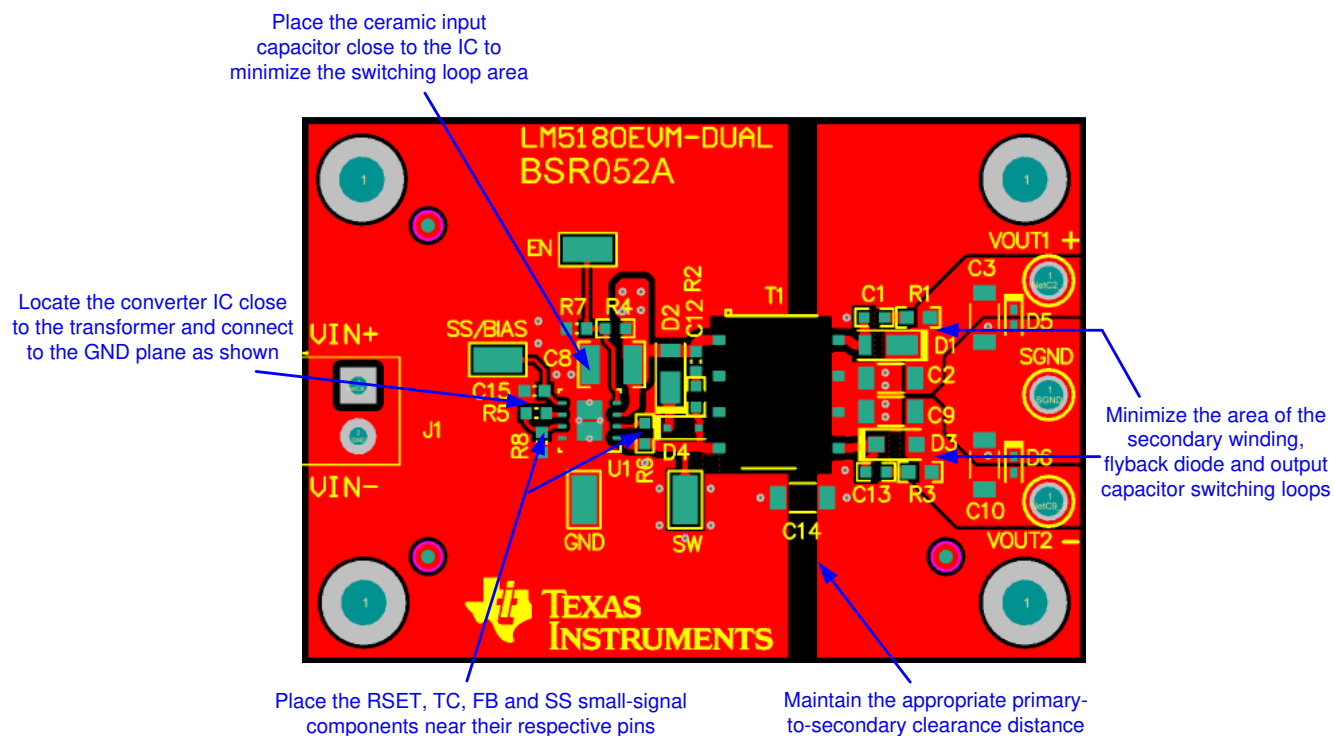


Figure 22. Layout Design Tips for a Dual-output PSR Flyback Converter

8 Device and Documentation Support

8.1 Device Support

8.1.1 Development Support

For development support, see the following:

- For TI's reference design library, visit [TI Designs](#)
- For TI's WEBENCH Design Environments, visit the [WEBENCH® Design Center](#)
- LM5180 PSR Flyback Converter [Quickstart Calculator](#) and [PSPICE](#) simulation model

8.2 Documentation Support

8.2.1 Related Documentation

For related documentation, see the following:

- [LM5180EVM-S05 EVM User's Guide](#) (SNVU592)
- [LM25184EVM-S12 EVM User's Guide](#) (SNVU680)
- [IC Package Features Lead to Higher Reliability in Demanding Automotive and Communications Equipment Systems](#) (SNVA804)
- [PSR Flyback Transformer Design for mHEV Applications](#) (SNVA805)
- [How an Auxless PSR Flyback Converter can Increase PLC Reliability and Density](#) (SLYT779)
- [Why Use PSR-Flyback Isolated Converters in Dual-Battery mHEV Systems](#) (SLYT791)
- TI Designs:
 - [Isolated IGBT Gate-Drive Power Supply Reference Design With Integrated Switch PSR Flyback Controller](#)
 - [Compact, Efficient, 24-V Input Auxiliary Power Supply Reference Design for Servo Drives](#)
 - [Reference Design for Power-Isolated Ultra-Compact Analog Output Module](#)
 - [HEV/EV Traction Inverter Power Stage with 3 Types of IGBT/SiC Bias-Supply Solutions Reference Design](#)
 - [4.5-V to 65-V Input, Compact Bias Supply With Power Stage Reference Design for IGBT/SiC Gate Drivers](#)
 - [Channel-to-Channel Isolated Analog Input Module Reference Design](#)
 - [SiC/IGBT Isolated Gate Driver Reference Design With Thermal Diode and Sensing FET](#)
 - [>95% Efficiency, 1-kW Analog Control AC/DC Reference Design for 5G Telecom Rectifier](#)
 - [3.5-W Automotive Dual-output PSR Flyback Regulator Reference Design](#)
- TI Technical Articles:
 - [Flyback Converters: Two Outputs are Better Than One](#)
 - [Common Challenges When Choosing the Auxiliary Power Supply for Your Server PSU](#)
 - [Maximizing PoE PD Efficiency on a Budget](#)
- White Papers:
 - [Valuing Wide \$V_{IN}\$, Low EMI Synchronous Buck Circuits for Cost-driven, Demanding Applications](#) (SLYY104)
 - [An Overview of Conducted EMI Specifications for Power Supplies](#) (SLYY136)
 - [An Overview of Radiated EMI Specifications for Power Supplies](#) (SLYY142)
- [Under the Hood of Flyback SMPS Designs](#) (SLUP261)
- [Flyback Transformer Design Considerations for Efficiency and EMI](#) (SLUP338)

8.2.1.1 PCB Layout Resources

- [AN-1149 Layout Guidelines for Switching Power Supplies](#) (SNVA021)
- [AN-1229 Simple Switcher PCB Layout Guidelines](#) (SNVA054)
- [Constructing Your Power Supply – Layout Considerations](#) (SLUP230)
- [Low Radiated EMI Layout Made SIMPLE with LM4360x and LM4600x](#) (SNVA721)
- TI Technical Articles:
 - [High-Density PCB Layout of DC-DC Converters](#)

8.2.1.2 Thermal Design Resources

- [AN-2020 Thermal Design by Insight, Not Hindsight](#) (SNVA419)
- [AN-1520 A Guide to Board Layout for Best Thermal Resistance for Exposed Pad Packages](#) (SNVA183)
- [Semiconductor and IC Package Thermal Metrics](#) (SPRA953)
- [Thermal Design Made Simple with LM43603 and LM43602](#) (SNVA719)
- [PowerPAD Thermally Enhanced Package](#) (SLMA002)
- [PowerPAD Made Easy](#) (SLMA004)
- [Using New Thermal Metrics](#) (SBVA025)

Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from A Revision (April 2019) to B Revision	Page
• Added family of PSR flyback converters in Table 1	1
• Updated Section 1.1	3
• Added PCB layout tips in Section 7.4	19
• Updated list of collateral in Section 8	20

Changes from Original (October 2018) to A Revision	Page
• Changed soft-start time, t_{ss} from "4 ms" to "8 ms"	4
• Changed part number for T1 (Würth Elektronik) from "TBD" to "750317595"	16

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